

Keys Semicon		Product	Doc. No.:	Version: C
旭揚半導體股 KeyStone Semice	份有限公司 onductor Corp.	Specificati	Model No.: T2	_L4A_8650C
2_L4A_86	50C DAB / DA	AB+ / FM mod	ule specification	
eatures :			-	
ETSI EN	300 401 compliant	t receiver		
Ultra low	-power DAB/FM b	baseband reception		
DAB/DA	B+ sensitivity to -9	99dBm (typical)		
DAB Col	or Slide show supp	oort		
DMB vid	eo service support			
TPEG/TN	AC support for GPS	S applications		
Decodes a	audio services up to	o 256kbps without	external RAM	
FM with 1	RDS			
(RDS rec	eption is subject to	certain condition of	of power level and frequ	ency deviation.)
Combined	d antenna input for	FM / Band3		
Support E	DAB L-band recept	tion		
Serial cor	ntrol interface			
RoHS con	mpliant			
Approved by	Verified by	Made by I	Date of modification:	Date of establishmer
JC Hsu	William Chang	Andy Liang	Sep 13 2011	Sep 3 2010



Revision History									
Rev.	Revise page	Revise Contents	Date	Ref. No.	Reviser				
А		Initial document							
В	Page 14	Modify FM operation band	05/27/10'		Andy Liang				
	Page 16	Modify FM performance	05/27/10'		Andy Liang				
С	Page 16	Modify FM performance	06/11/10'		Andy Liang				
D	Page 16	Modify FM performance	09/03/10'		Andy Liang				
E	Page 16	Modify FM performance	08/01/11'		Andy Liang				
F		Modify input DC range	09/08/11'		Andy Liang				
G		Add TPEG/TMC support	09/13/11'		Andy Liang				



Contents						
No.	Item	Page				
1	General description					
2	Application					
3	Introduction					
3-1	Block Diagram					
3-2	Master mode Application					
4	Software					
5	Mechanical specification					
5-1	T2_L4A_8650C mechanical drawing					
5-2	Module pin descriptions					
5-3	Weight					
6	Hardware interface					
6-1	RF input					
6-2	Analogue audio output					
6-3	Serial port					
6-4	I ² C interface					
6-5	Power and ground					
6-6	LCM					
6-7	Keyboard					
6-8	GPIO pins					
6-9	Roll switch					
6-10	SPI interface and GPIO					
6-11	Power-Down control					
7	Technical specification					
7-1	Input description					
7-2	Signal format					
7-3	Analogue audio output					
7-4	Power supply voltage					
7-5	Environmental specification					
8	Standard test conditions					
8-1	Ambient conditions					
8-2	Power supply					
8-3	Current consumption					
9	Absolute maximum voltage					
10	Electrical specification					
	Compliance standards					
	Electromagnetic compatibility (EMC)					
11-2	Electrostatic discharge (ESD) protection					



1. General description

The T2_L4A_8650C module is a new generation of DAB/DAB+/DAB-Radio/FM radio modules to use the KSW8650 chipset. T2_L4A_8650C is designed to enable dual or tri-band DAB/DAB+/DMB-Radio/FM receivers of various types to be produced at lower cost. T2_L4A_8650C would operate in master mode stand alone or accepts commands by an external microcontroller and provide DMB-R, DMB-Video, color slide show, and TPEG or TMC bit stream to external host through SPI or UART. "T2_L4A_8650C" is pin-to-pin compatible with previous generation "T1_L4A_8290C".

T2_L4A_8650C includes all the interfaces necessary so that manufacturers need only add power supply, display, keypad, audio amplifier and speakers to provide a fully functional DAB/DAB+/DAB-Radio /FM radio.

2. Application

- Portable radio
- Clock radio
- Kitchen radio
- Boombox
- Hi-Fi radio
- Digital frame
- Car-radio
- Mini-CD system
- DVD player
- Multimedia System
- iPhone/iPod Docking System
- Personal Navigation Device



3. Introduction

3-1 Block Diagram

Figure 1 shows a block diagram of the T2_L4A_8650C. The main component is single chip, KSW8650 which provides baseband processor, RF processor, Flash memory and Audio DAC.



Figure 1 : Module Block Diagram

T2_L4A_8650C's dimension is 26 x 26 mm, and Hardware interface includes analogue stereo audio / LCD control / Keypad / GPIO / I ^{2}C / SPI / UART.





Figure 2&3 show a master and slave mode application block diagram of the T2_L4A_8650C.













5-2 Module Pin Descriptions

Pin No.	Pin name	Pin Description	Note		
1	AinSen_0/IR	Roll switch with Infrared receiver input	Roll_A0 and IR are pin sharing		
2	BinSen_0	Roll switch			
3	AinSen_1	Roll switch			
4	BinSen_1	Roll switch			
5	GND	GND			
6	1.2V	+1.2V power supply			
7	I2C_SCL	I ² C clock			
8	I2C_SDA	I ² C data			
9	LCD_CTRL0				
10	LCD_CTRL1	LCD control pipe			
11	LCD_CTRL2	LCD control pins			
12	LCD_CTRL3				
13	LCD_D2	LCD data pipe	Option : SPI_DI		
14	LCD_D0		Option : SPI_CSB		
15	GND	GND			
16	GND	GND			
17	LCD_D3	LCD data pins	Option : SPI_DO		
18	LCD_D1	LCD data pins	Option : SPI_CLK		
19	Scan_Key_O1/LCD_D5	LCD data pins and scan key			
20	Scan_Key_O0/LCD_D4	output pin sharing			
21	LCD_CTRL4	GPIO			
22	Scan_Key_I3	Scan Key input pin	Option: I2S_SBCLK		
23	Scan_Key_O2/LCD_D6	LCD data pins and scan key			
24	Scan_Key_O3/LCD_D7	output pin sharing			
25	Scan_Key_I2	Scan Key input pin	Option: I2S_SSCLK		
26	LOUT	Stereo audio output			
27	ROUT	Stereo audio output			
28	Scan_Key_I0	Scan Key input pin	Option: I2S_SDATAO		
29	Scan_Key_I1	Scan Key input pin	Option: I2S_SSYNC		
30	3.3V	+3.3V power supply			
31	D2DENB	External LDO enable	Need pull-up to BAT_IN		
32	RESETB	HW reset input pin	Low for reset		

 ${\it KeyStone\ Semiconductor\ Confidential\ \&\ Proprietary.\ No\ copy\ allowed\ without\ written\ authorization.\ P.9/17}$



Pin	Din nome	Din Decerintian	Nata		
No.	Pin name	Pin Description	NOLE		
33	USE32K	XTAL selection	Low for normal operation		
34	BAT_DET	Battery voltage detect input pin			
35	BAT_IN	Battery input pin for system and RTC			
36	POWERUP	Low for power up			
37	GND	GND			
38	B3&FM_RFin	RF input for B3 and FM			
39	GND	GND			
40	GND	GND			
41	LBand_RFin	RF input for L-band			
42	GND	GND			
43	GND	GND			
44	EXTINT	External interrupt input			
45	GND	GND			
46	1.8V	+1.8V power supply			
47	UART_TXD	UART TXD			
48	UART_RXD	UART RXD			

*T2_L4A_8650C is pin-to-pin compatible with T1_L4A_8290C.

5-3 Weight of module

2g



6. Hardware interface

6-1 RF Input

The T2_L4A_8650C has two RF inputs, one can support both Band 2(FM) and Band 3(DAB), the other can support L-Band(DAB)

6-2 Analogue audio output

Stereo audio outputs are provided by KSW8650's on-chip audio DAC with built-in headphone amplifiers. And can be directly connected to a 320hm headphone without external headphone amplifiers to save cost and form-factor.

6-3 Serial port

Serial port pins (UART_RXD, UART_TXD) runs RS232 protocol, and can interface to external host or PC. Software control is required on this serial port.

6-4 I ²C interface

I ²C interface can be used to communicate with I2CLCM, EPROM or other I2C devices. I2C need pull-up resisters on I2C_SCL and I2C_SDA.

6-5 Power and ground

3.3V is used for KSW8650's I/O, 1.8V power supply is for RF, and 1.2V power supply is for baseband processors. Noise and spurs associated with these power supplies should be kept as low as possible to ensure high receiving sensitivity performance.

GND is the lowest potential of the T2_L4A_8650C, and it should connect to true ground by a plane as close as possible.

6-6 LCM

T2_L4A_8650C module provides three series LCM control interfaces:

a) Character LCM Control Interface

T2_L4A_8650C module offers a wide range of character LCM control interfaces to fit for customer's applications. It provides three data-bus modes: 1-bit mode, 4-bit mode and 8-bit mode. The firmware now supports all these three data-bus modes and is able to control the standard 2x16 and 4x16 LCM with or without customized icons.

The following lists the LCM controllers that have been tested and qualified for used with T2_L4A_8650C.

- Sitronix ST7032 (2x16 Characters)
- Sitronix ST7070 (4x16 Characters)
- Samsung KS0066 (2x16 Characters)
- SunPlus SPLC780C (2x16 Characters)



b) Serial Control Interface

T2_L4A_8650C also supports I2C and SPI Character LCM such as Sitronix ST7032i (I2C), Philips PCF2116 (I2C) and Samsung KS0074 (SPI).

c) Parallel Control Interface

There are two popular parallel control interfaces used especially in the graphic LCM: Motorola 6800-series and Intel 8080-series parallel interface. The following lists the LCM controllers that have been tested and qualified for used with T2_L4A_8650C.

Sitronix ST7565R (65 x 132 Dot Matrix LCD Controller)

- Solomon Systech SSD1303 (OLED driver/controller IC)
- Novatek NT7501
- PTC PT6866 (OLED driver/controller IC)

LCD interface contains 8 data pins (LCD_D[0:7]) and 4 control pins (LCD_CTRL[0:3]) to drive typical 2x16 LCD display or OLED display.

LCD_CTRL3 is configured to control the backlight of the LCD panel.

LCD_D[0:3] can be configured as GPIO if 8-bit data mode is not needed.

In order to prevent the LCD interface interference, a serial resistor under 2kohm should be placed on each LCD output lines as close to module as possible.

6-7 Keyboard

SCAN_IN[0:3] and SCAN_OUT[0:3] forms a 4x4 key matrix consist of 16 key pads. A key is detected when it shorts (pressed) the intersection of any SCAN_IN and SCAN_OUT lines. In order to prevent scan key interference, a serial resister 3.3Kohm with shunt 560pF capacitor should be placed on each scan key output pins as close to module as possible.

6-8 GPIO

Every digital pin of theT2_L4A_8650C has a main function plus a GPIO function. If an application does not use the main function of a pin, then it can be reconfigured to input, output or bi-directional function through software configuration.

All GPIO pins are input mode as reset default value, and FW can configure each GPIO to its main function.

6-9 Roll switch

Two sets of Roll Switch inputs are provided. Roll Switch used 2-pin phase-encoder to determine the direction and counts of rotation.



6-10 IR receiver

T2_L4A_8650C provide one IR receiver sharing pin with AinSen_0 since the IR is not functional together with roll switch.

6-11 SPI interface

LCD_D[0:3] can be configured as SPI interface if LCD_D[0:3] are not used. SPI interface is the default data transmitting path for Host to decode DMB video stream. T2 L4A 8650C supports both master and slave SPI application.

6-12 I2S interface

L4A support I2S output for optional and two formats are supported: 32-bit I2S format and 32-bit Right justified format.

I2S format:



6-13 H/W reset

The external H/W reset control is required. Either controlled by external MCU in slave mode or just simple 100k ohm resister pull up with 0.1uF capacitor to ground as power on reset are recommended.

 $\textit{KeyStone Semiconductor Confidential \& Proprietary. No copy allowed without written authorization. P. 13/17$



. Iech	mean Specification			
No.	Item	Conditions		
7-1	RF/IF Description			
	(1) Input frequency range	FM : 87.5~108MHz		
		Band-3 : 174~240MHz		
		L-Band : 1452MHz~1492MHz		
	(2) Antenna impedance	50 Ω		
	(3) IF frequency	FM: 108kHz		
		DAB: 1MHz		
7-2	Signal format	FM : BS5942-2 / BS 60315-4		
		DAB : ETSI EN 300 401		
		All Modes (I II III and IV) support		
7-3	Analogue audio output	Stereo audio output		
7-4	Power supply voltage			
	Pin46	$+1.8V\pm10\%$		
	Pin6	$+1.2V\pm10\%$		
	Pin30	+3.3V±10%		
7-5	Environmental specification			
7-5-1	Temperature			
	Operating	$0 \sim +70$ ° C		
	Storage	-20 ~ +70 ° C		
7-5-2	Humidity			
,	Operating	Less than 80% RH(at 40 ° C)		
	Storage	Less than 95% RH(at 40 ° C)		
	Storage			



8. Standard Test Conditions

Test for electrical specifications shall be performed at following condition unless otherwise specified.

No.	Item	Conditions			
8-1	Ambient Condition				
	Temperature	25 ° C			
8-2	Power Supply				
	+1.2V (Pin 6)	1.2 V DC , ripple $\leq 10 \text{mVpp}$			
	+1.8V (Pin 46)	1.8 V DC , ripple $\leq 10 \text{mVpp}$			
8-3	+3.3V (Pin 30)	3.3 V DC , ripple $\leq 10 \text{mVpp}$			
	Current Consumption (mA)	Typ. Max.			
	DAB Mode*				
	+1.2V (RMS)	48 75			
	+1.8V (RMS)	45 68			
	+3.3V (RMS)	15 20			
	FM Mode				
	+1.2V (RMS)	56 62			
	+1.8V (RMS)	64 70			
	+3.3V (RMS)	15 20			

* : Data marked as is still preliminary, need to be confirmed.

9. Absolute Maximum Ratings

No	Item	Max.	Unit
9-1	VDD12 Power Supply	1.5	
9-2	VDD18 Power Supply	2.1	
9-3	VDD33 Power Supply	3.9	V
9-4	RF IO Pad Input Voltage	-0.3 to VDD18+0.3	
9-5	Digital & Analog IO Pad Input Voltage	-0.3 to VDD33+0.3	

10.DC Operating Condition

No	Itom	Specification				
INU	Item	Min.	Тур.	Max.	Unit	
10-1	+1.2 Power Supply	-0.3	+1.2	+1.35		
10-2	+1.8 Power Supply	-0.3	+1.8	+2.0	V	
10-3	+3.3 Power Supply	-0.3	+3.3	+3.6		



11. Electrical Specifications

11-1 DAB Band-3 Performance

N	T4	Specification				C. I't'
INU	Item	Min.	Тур.	Max.	Unit	Condition
11-1-1	Sensitivity		-99		dBm	
11-1-2	RF input large signal		-7		dBm	
11-1-3	Far off selectivity		55		dB	$N \pm 5MHz$
11-1-4	Adjacent channel		30		dB	N±1
11-1-5	Audio output impedance	16	32		Ω	
11-1-6	Audio output voltage		2.0V	2.6V	V_{pp}	
11-1-7	THD		0.026		%	@32ohm load
11-1-8	SNR	81	81		dB	@32ohm load
11-1-9	Stereo separation	53	53		dB	@32ohm load
11-1-10	Audio 3dB cutoff	f freque	ncy		Hz	@32ohm load
	Low		42			
	Higher		20000			

11-2 FM Performance

Na	Itom	Specification				Condition			
INO	Item	Min.	Тур.	Max.	Unit				
11-2-1	Sensitivity		-108		dDm				
	@(S+N)/N=26dB				dBm				
11-2-2	RF input large signal		-7		dBm				
11-2-3	Far off selectivity		45		dB				
11-2-4	Adjacent channel		36		dB				
11-2-5	Audio	16	32		Ω				
	output impedance								
11-2-6	Audio output voltage		440		mV _{pp}	*			
11-2-7	THD		0.22		%	*			
11-2-8	SNR		52		dB	*			
11-2-9	Stereo separation		26		dB	@32ohm load			
	Audio 3dB cu	utoff fre	quency		Hz	@32ohm load			
11-2-10	Low		30			*			
	High		12500			Audio 3dB BW			
* L=R ,	* L=R , Δ F=22.5KHz,F _{mod} =1KHz,de-emphasis=75us, @32ohm ohm load								

 ${\it KeyStone\ Semiconductor\ Confidential\ \&\ Proprietary.\ No\ copy\ allowed\ without\ written\ authorization.\ P.16/17}$



12. Compliance standards

12-1 Electromagnetic compatibility(EMC)

T2_L4A_8650C module is tested to comply with the following standard:

BS EN 55022:1998

BS EN 55013:2001

The electromagnetic compatibility of a particular product is highly dependent on the usage environment and how the module is installed within final product. Care should be taken to integrate the module with due regard to the effects of conducted and radiated signals.

12-2 Electrostatic discharge (ESD) protection

T2_L4A_8650C module is an ESD-sensitive device and is tested to IEC 61000-4-2 standard. Special precautions should be taken during manufacturing and testing process.